

Electronic Acknowledgement Receipt

EFS ID:	2234683
Application Number:	10632550
International Application Number:	
Confirmation Number:	2570
Title of Invention:	SEMICONDUCTOR MULTI-PACKAGE MODULE INCLUDING STACKED-DIE PACKAGE AND HAVING WIRE BOND INTERCONNECT BETWEEN STACKED PACKAGES
First Named Inventor/Applicant Name:	Marcos Karnezos
Customer Number:	22470
Filer:	Mikio Ishimaru/Meghan Calhoun
Filer Authorized By:	Mikio Ishimaru
Attorney Docket Number:	CPAC 1017-7
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Application Type:	Utility under 35 USC 111(a)

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Power of Attorney	27-405-6_ChipPAC_Inc_sign ed_POA.pdf	71697 <small>9a95ecd80b32db457ab03a2f14c1d9a0916d960e</small>	no	1

Warnings:

Information:					
2	Assignee showing of ownership per 37 CFR 3.73(b).	27-405-6_STATEMENT_und er_3-73b.pdf	66522 <small>906029e0d0f33ad1ff6c5d45281ffc3491e8 85503a</small>	no	1
Warnings:					
Information:					
3	Change of Address	27-405-6_Fee_Address_Indi cation_Form.pdf	65917 <small>8c818e97492bdc3a3836c7c5119c58e127 3e3994e3</small>	no	1
Warnings:					
Information:					
Total Files Size (in bytes):			204136		
<p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p><u>New Applications Under 35 U.S.C. 111</u> If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p><u>National Stage of an International Application under 35 U.S.C. 371</u> If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p> <p><u>New International Application Filed with the USPTO as a Receiving Office</u> If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.</p>					